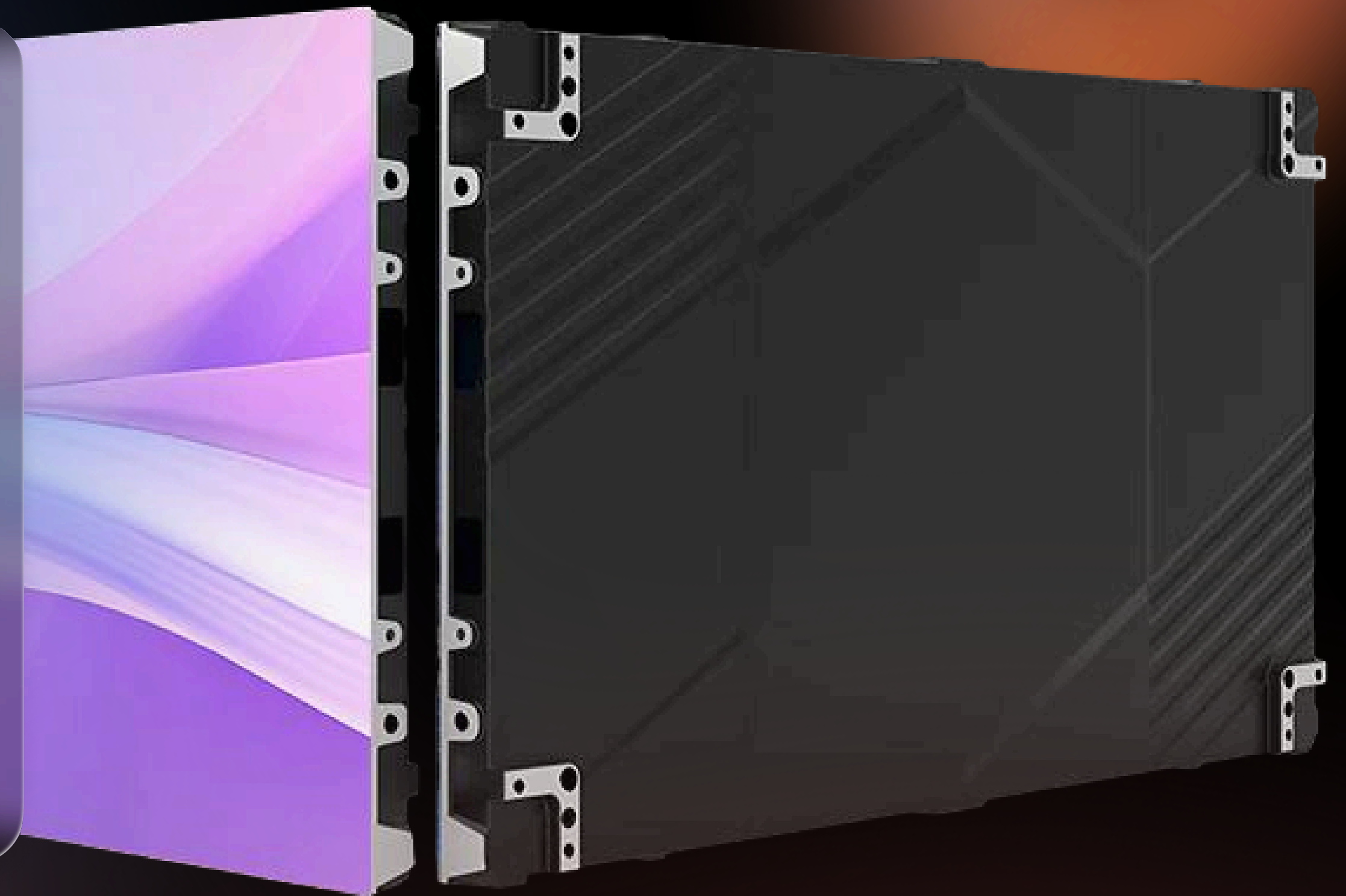


Flip Chip COB LED Display

Pixel Pitches: P0.625/P0.78/P0.93/P1.25/P1.56/P1.87mm

- ✓ **Better display performance:** Chip-on-Board (COB) packaging technology uses surface light sources for illumination, resulting in high color fidelity and better detail representation, making it suitable for high-resolution imaging
- ✓ **Reliability:** High integration reduces the number and size of components, thereby reducing the failure rate.
- ✓ **Excellent heat dissipation:** The heat of the COB display screen is dissipated directly through the PCB board, making it suitable for harsh environments and long-duration operating scenarios



Product details & specifications

Better Contrast & Color Uniformity



Wide view angle without color shift



Front access

